

[Your Name]

[Your Address]

[City, State, Zip Code]

[Email Address]

[Phone Number]

[Date]

Embassy of [Country]

[Embassy Address]

[City, State, Zip Code]

Dear Sir/Madam,

I hope this message finds you well. I am writing to inquire about the current processing time for a bonding visa application that I submitted on [Date of Application].

My application reference number is [Application Reference Number]. I would appreciate any updates regarding the status of my application and the estimated time frame for processing.

Thank you for your attention to this matter. I look forward to your prompt response.

Sincerely,

[Your Name]